

(V) Preliminary Specifications() Final Specifications

Module	WXGA Color TFT-LCD with LED Backlight design		
Model Name	B121EW09 V6 (HW: 0A)		
Note (🗭)	LED Backlight with driving circuit design		

Customer	Date	Approved by	Date
Checked & Approved by	Date	Prepared by	
		Kay CY Wang	04/27/2010
Note: This Specification is su notice.	bject to change without	NBBU Marketi AU Optronics	



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Record of Revision

Version and Date	Page	Old description	New Description	Remark
0.1 2010/04/27	All	N/A	Preliminary SPEC	

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1. Handling Precautions

- 1) Since front polarizer is easily damaged, pay attention not to scratch it.
- 2) Be sure to turn off power supply when inserting or disconnecting from input connector.
- 3) Wipe off water drop immediately. Long contact with water may cause discoloration or spots.
- 4) When the panel surface is soiled, wipe it with absorbent cotton or other soft cloth.
- 5) Since the panel is made of glass, it may break or crack if dropped or bumped on hard surface.
- 6) Since CMOS LSI is used in this module, take care of static electricity and insure human earth when handling.
- 7) Do not open nor modify the Module Assembly.
- 8) Do not press the reflector sheet at the back of the module to any directions.
- 9) At the insertion or removal of the Signal Interface Connector, be sure not to rotate nor tilt the Interface Connector of the TFT Module.
- 11)After installation of the TFT Module into an enclosure (Notebook PC Bezel, for example), do not twist nor bend the TFT Module even momentary. At designing the enclosure, it should be taken into consideration that no bending/twisting forces are applied to the TFT Module from outside. Otherwise the TFT Module may be damaged.
- 12) Small amount of materials having no flammability grade is used in the LCD module. The LCD module should be supplied by power complied with requirements of Limited Power Source (IEC60950 or UL1950), or be applied exemption.
- 13)Disconnecting power supply before handling LCD modules, it can prevent electric shock, DO NOT TOUCH the electrode parts, cables, connectors and LED circuit part of TFT module that a LED light bar build in as a light source of back light unit. It can prevent electrostic breakdown.

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2. General Description

B121EW09 V6 is a Color Active Matrix Liquid Crystal Display composed of a TFT LCD panel, a driver circuit, and LED backlight system. The screen format is intended to support the WXGA (1280(H) x 800(V)) screen and 262k colors (RGB 6-bits data driver) with LED backlight driving circuit. All input signals are LVDS interface compatible.

B121EW09 V6 is designed for a display unit of notebook style personal computer and industrial machine.

2.1 General Specification

The following items are characteristics summary on the table at 25 $^{\circ}\mathrm{C}$ condition:

Items	Unit	Specifications				
Screen Diagonal	[mm]	307.9 (W")				
Active Area	[mm]	261.12(H) X	163.20(V)			
Pixels H x V		1280x3(RGB) x 800			
Pixel Pitch	[mm]	0.204X0.204				
Pixel Arrangement		R.G.B. Vertic	al Stripe			
Display Mode		Normally Wh	ite			
White Luminance (ILED=20mA)	[cd/m ²]	200 typ. (5 po 170 min. (5 p	oints average ooints average	,		
Luminance Uniformity		1.25 max. (5	points)			
Contrast Ratio		400 typ				
Response Time	[ms]	16 typ / 25 M	ax			
Nominal Input Voltage VDD	[Volt]	+3.3 typ.				
Power Consumption	[Watt]	5W max. (Inc	clude Logic ar	nd Black Ligl	ht power)	
Weight	[Grams]	290 max.				
Physical Size	[mm]		L	W	Т	
		Max	277.3	178.65	5.5	
		Typical 276.8 178.15 -				
Electrical Interface		Min				
Surface Treatment		Glare				

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Support Color		262K colors (RGB 6-bit)
Temperature Range Operating Storage (Non-Operating)	[°C] [°C]	0 to +50 -20 to +65
RoHS Compliance		RoHS Compliance

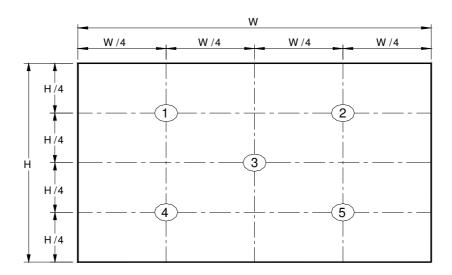
2.2 Optical Characteristics The optical characteristics are measured under stable conditions at 25 $^\circ$ C (Room Temperature) :

·					,			11	NI-1-
Item		Symbol	Condit	ions	Min.	Тур.	Max.	Unit	Note
White Lumir			5 points average		170	200	-	cd/m	1, 4, 5.
		$ heta_{ extsf{R}}$	Horizontal	(Right)	40	45	-	degre	
Viewing Angle		$ heta_{ extsf{L}}$	CR = 10	(Left)	40	45	•	е	
Viewing Ai	igie	<i>ф</i> н	Vertical	(Upper)	10	15	-		4, 9
		φ L	CR = 10	(Lower)	30	35	-		
Luminan Uniformi		δ _{5P}	5 Poi	nts	-	-	1.25		1, 3, 4
Luminan Uniformi		δ 13P	13 Points		•	ı	1.50		2, 3, 4
Contrast R	atio	CR				400	-		4, 6
Cross ta	lk	%					4		4, 7
		T _r	Rising		-	_	-		
Response ⁻	Гime	T _f	Falling		-		-	msec	4, 8
		T _{RT}	Rising + Falling		-	16	25		
	Dod	Rx			0.529	0.559	0.589		
	Red	Ry			0.318	0.348	0.378		
	Green	Gx			0.312	0.342	0.372		
Color /	Green	Gy			0.529	0.559	0.589		
Coodinates	Chromaticity Coodinates		CIE 1	931	0.120	0.150	0.180		4
	Blue	Ву			0.078	0.108	0.138		
	\A/I=!!	Wx			0.283	0.313	0.343		
	White	Wy			0.299	0.329	0.359		
NTSC		%			-	45	•		

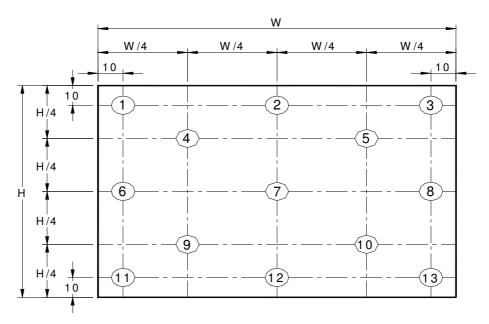
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Note 1: 5 points position (Ref: Active area)



Note 2: 13 points position (Ref: Active area)



Note 3: The luminance uniformity of 5 or13 points is defined by dividing the maximum luminance values by the minimum test point luminance

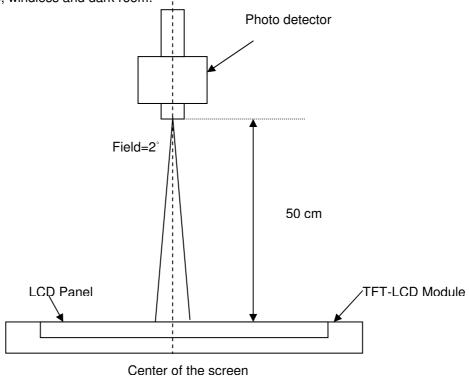
6		Maximum Brightness of five points
රි w5	= '	Minimum Brightness of five points
2		Maximum Brightness of thirteen points
δ w13	= '	Minimum Brightness of thirteen points

Note 4: Measurement method



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The LCD module should be stabilized at given temperature for 30 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting Backlight for 30 minutes in a stable, windless and dark room.



Note 5: Definition of Average Luminance of White (Y_L):

Measure the luminance of gray level 63 at 5 points \cdot $Y_L = [L (1) + L (2) + L (3) + L (4) + L (5)] / 5 L (x) is corresponding to the luminance of the point X at Figure in Note (1).$

Note 6: Definition of contrast ratio:

Contrast ratio is calculated with the following formula.

Note 7: Definition of Cross Talk (CT)

$$CT = |Y_B - Y_A| / Y_A \times 100 (\%)$$

Where

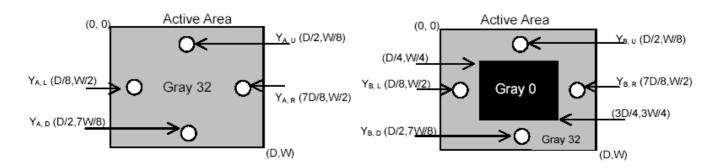
Y_A = Luminance of measured location without gray level 0 pattern (cd/m₂)

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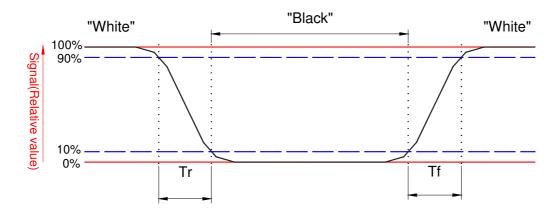
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Y_B = Luminance of measured location with gray level 0 pattern (cd/m₂)



Note 8: Definition of response time:

The output signals of BM-7 or equivalent are measured when the input signals are changed from "Black" to "White" (falling time) and from "White" to "Black" (rising time), respectively. The response time interval between the 10% and 90% of amplitudes. Refer to figure as below.



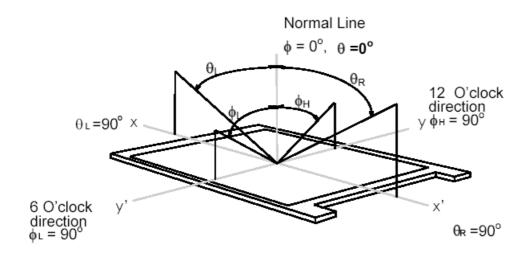
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Note 8. Definition of viewing angle

Viewing angle is the measurement of contrast ratio \geq 10, at the screen center, over a 180° horizontal and 180° vertical range (off-normal viewing angles). The 180° viewing angle range is broken down as follows; 90° (θ) horizontal left and right and 90° (Φ) vertical, high (up) and low (down). The measurement direction is typically perpendicular to the display surface with the screen rotated about its center to develop the desired measurement viewing angle.

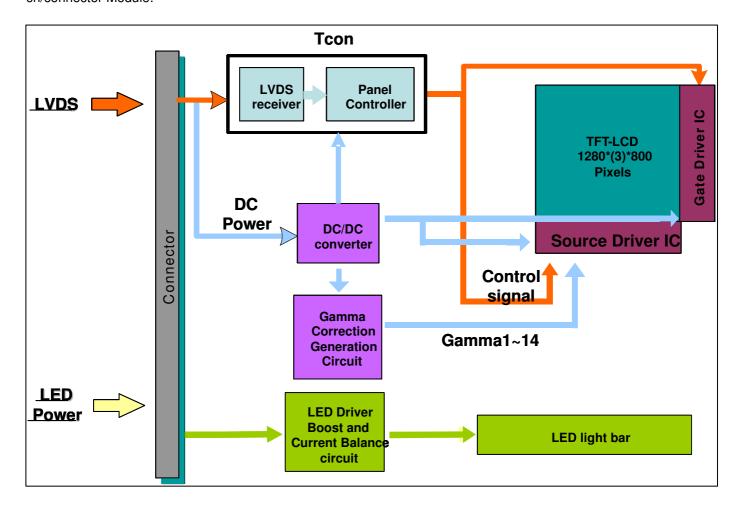


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3. Functional Block Diagram

The following diagram shows the functional block of the 12.1 inches wide Color TFT/LCD 40 Pin (One ch/connector Module:





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4. Absolute Maximum Ratings

An absolute maximum rating of the module is as following:

4.1 Absolute Ratings of TFT LCD Module

Item	Symbol	Min	Max	Unit	Conditions
Logic/LCD Drive Voltage	Vin	-0.3	+4.0	[Volt]	Note 1,2

4.2 Absolute Ratings of Backlight Unit

Item	Symbol	Min	Max	Unit	Conditions
LED Driving Voltage	V_{LED}	-	36 (Row Output)	[Volt]	Note 1,2,3
LED Driving Current	I _{LED}	-	30 (Row Output)	[mA] rms	Note 1,2,3

4.3 Absolute Ratings of Environment

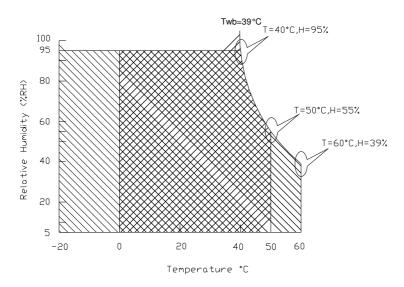
Item	Symbol	Min	Max	Unit	Conditions
Operating Temperature	TOP	0	+50	[°C]	Note 4
Operation Humidity	HOP	10	90	[%RH]	Note 4
Storage Temperature	TST	-20	+65	[°C]	Note 4
Storage Humidity	HST	10	90	[%RH]	Note 4

Note 1: At Ta (25°C)

Note 2: Permanent damage to the device may occur if exceed maximum values

Note 3: LED specification refer to section 5.2

Note 4: For quality performance, please refer to AUO IIS (Incoming Inspection Standard).



Operating Range

Storage Range

+

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5. Electrical characteristics

5.1 TFT LCD Module

5.1.1 Power Specification

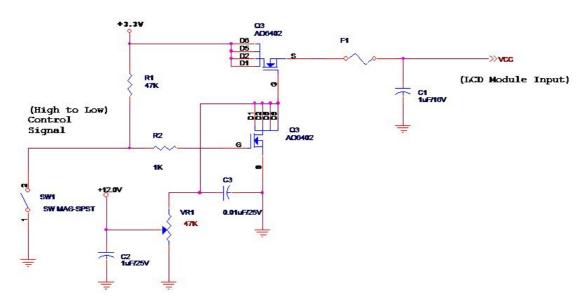
Input power specifications are as follows;

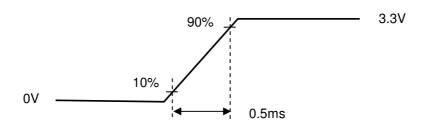
Symble	Parameter	Min	Тур	Max	Units	Note
VDD	Logic/LCD Drive Voltage	3.0	3.3	3.6	[Volt]	
PDD	VDD Power	-		0.9	[Watt]	Note 1/2
IDD	IDD Current	-	-	250	[mA]	Note 1/2
lRush	Inrush Current	-	-	2000	[mA]	Note 3
VDDrp	Allowable Logic/LCD Drive Ripple Voltage	-	-	100	[mV] p-p	

Note 1: Maximum Measurement Condition: Black Pattern

Note 2: Typical Measurement Condition: Mosaic Pattern

Note 3: Measure Condition





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5.1.2 Signal Electrical Characteristics

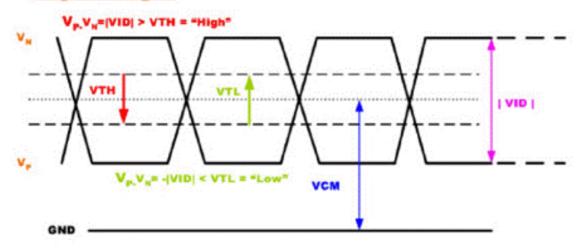
Input signals shall be low or High-impedance state when VDD is off.

Signal electrical characteristics are as follows;

Parameter	Condition	Min	Max	Unit
V _{TH}	Differential Input High Threshold (Vcm=+1.2V)		100	[mV]
V _{TL}	Differential Input Low Threshold (Vcm=+1.2V)	-100	-	[mV]
V _{ID}	Differential Input Voltage	100	600	[mV]
V _{CM}	Differential Input Common Mode Voltage	1.125	1.375	[V]

Note: LVDS Signal Waveform

Single-end Signal



5.2 Backlight Unit

LED Parameter guideline for LED driving selection (Ref. Remark 1)

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Parameter	Symbol	Min	Тур	Max	Units	Condition
LED Forward Voltage	V_{F}	2.95	3.15	3.35	[Volt]	(Ta=25°C)
LED Forward Current	l _F		20	30	[mA]	(Ta=25°C)
LED Power consumption	P _{LED}		3.78		[Watt]	(Ta=25°C) Note 1
LED Life-Time	N/A	12,000	-	-	Hour	(Ta=25°C) I _F =20 mA Note 2
Output PWM frequency	FPWM	-	200	20K	Hz	
Duty ratio		5		100	%	

Note 1: Calculator value for reference IF×VF× 42/ efficiency(85%)=P(typ.)

Note 2: The LED life-time define as the estimated time to 50% degradation of initial luminous.



6. Signal Characteristic

6.1 Pixel Format Image

Following figure shows the relationship of the input signals and LCD pixel format.

	0	1		1278	<mark>1279</mark>
1st Line	R G B	R G B		R G E	B R G B
		1	1		
	١ ١	1	•	1	
			•	•	
	.		•	•	•
	;	'	1	•	,
	1	1	1 1		
800th Line	R G B	R G B		R G E	B R G B

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6.2 The input data format

RxCLKIN	N	
RxIN0	G0 R5 R4 R3 R2 R1 R0	\searrow
RxIN1	B1 B0 G5 G4 G3 G2 G1	\rightarrow
RxIN2	DE VS HS B5 B4 B3 B2	\rightarrow

Signal Name	Description	
R5	Red Data 5 (MSB)	Red-pixel Data
R4	Red Data 4	Each red pixel's brightness data consists of
R3 R2	Red Data 3 Red Data 2	these 6 bits pixel data.
R1	Red Data 1	
R0	Red Data 0 (LSB)	
	Red-pixel Data	
G5	Green Data 5 (MSB)	Green-pixel Data
G4	Green Data 4	Each green pixel's brightness data consists of
G3	Green Data 3	these 6 bits pixel data.
G2 G1	Green Data 2 Green Data 1	
G0	Green Data 0 (LSB)	
Go	Groon Bala o (ESB)	
	Green-pixel Data	
B5	Blue Data 5 (MSB)	Blue-pixel Data
B4 B3	Blue Data 4 Blue Data 3	Each blue pixel's brightness data consists of
B2	Blue Data 2	these 6 bits pixel data.
B1	Blue Data 1	
B0	Blue Data 0 (LSB)	
	Blue-pixel Data	
RxCLKIN	Data Clock	The typical frequency is 69.3 MHZ. The signal is
		used to strobe the pixel data and DE signals. All
		pixel data shall be valid at the falling edge when the DE signal is high.
DE	Display Timing	This signal is strobed at the falling edge of
	1 -7 3	RxCLKIN. When the signal is high, the pixel
		data shall be valid to be displayed.
VS	Vertical Sync	The signal is synchronized to RxCLKIN.
HS	Horizontal Sync	The signal is synchronized to RxCLKIN.

Note: Output signals from any system shall be low or High-impedance state when VDD is off.

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6.3 Signal Description/Pin Assignment

LVDS is a differential signal technology for LCD interface and high speed data transfer device.

Pin	Signal	Description
1	NC	No Connection (Reserved for supplier)
2	VDD	Power Supply, 3.3V (typical)
3	VDD	Power Supply, 3.3V (typical)
4	VEDID	EDID 3.3V power
5	NC	No Connection
6	CLKEDID	EDID Clock Input
7	DATAEDID	EDID Data Input
8	RxIN0-	- LVDS differential data input (R0-R5, G0)
9	RxIN0+	+ LVDS differential data input (R0-R5, G0)
10	GND	Ground
11	RxIN1-	- LVDS differential data input (G1-G5, B0-B1)
12	RxIN1+	+ LVDS differential data input (G1-G5, B0-B1)
13	GND	Ground
14	RxIN2-	- LVDS differential data input (B2-B5,HS,VS, DE)
15	RxIN2+	+ LVDS differential data input (B2-B5,HS,VS, DE)
16	GND	Ground
17	RxCLKIN-	- LVDS differential clock input
18	RxCLKIN+	+ LVDS differential clock input
19	GND	Ground
20	NC	No Connection
21	NC	No Connection
22	GND	Ground
23	NC	No Connection
24	NC	No Connection
25	GND	Ground
26	NC	No Connection
27	NC	No Connection
28	GND	Ground
29	NC	No Connection
30	NC	No Connection
31	VBL-	LED Ground
32	VBL-	LED Ground
33	VBL-	LED Ground
34	NC	No Connection (Reserved for supplier)
35	VBL+	LED Power Supply 6V-20V
36	VBL+	LED Power Supply 6V-20V
37	VBL+	LED Power Supply 6V-20V
38	BLIM	PWM for luminance control (200~20KHz, 3.3V, 10~100%)
39	BL_Enable	BL On/Off (On: 2.0~3.3V, Off: 0~0.5V)
40	NC	No Connect (Reserve for AUO test)

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6.4 Interface Timing

6.4.1 Timing Characteristics

Basically, interface timings should match the 1280x800 /60Hz manufacturing guide line timing.

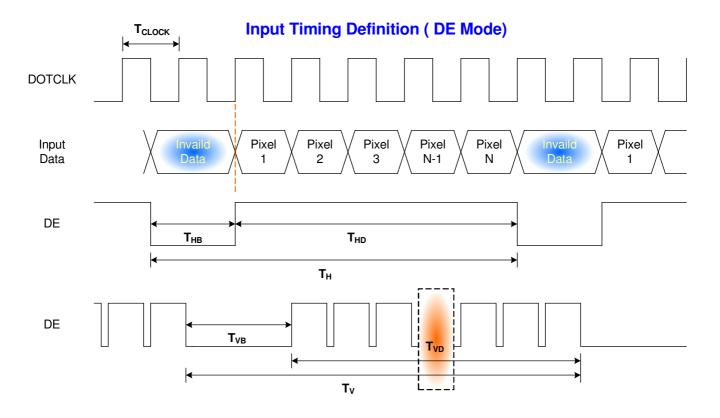
Parameter		Symbol	Min.	Тур.	Max.	Unit
Frame	e Rate	-	-	60	-	Hz
Clock frequency		1/ T _{Clock}	50-	69.3	80-	MHz
	Period	T _V	803	816	1023	
Vertical Section	Active	T _{VD}	800	800	800	\mathbf{T}_{Line}
	Blanking	T _{VB}	3	16	223	
	Period	T _H	1303	1416	2047	
Horizontal Section	Active	T _{HD}	1280	1280	1280	T_{Clock}
	Blanking	T HB	23	136	767	

Note: DE mode only

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6.4.2 Timing diagram

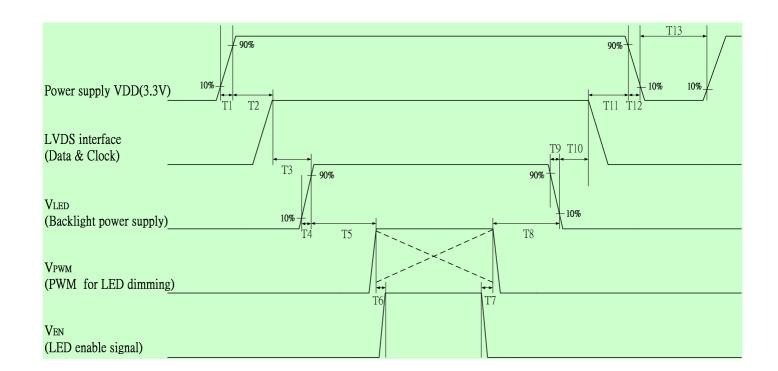




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6.5 Power ON /OFF Sequence

Power on/off sequence is as follows. Interface signals and LED on/off sequence are also shown in the chart. Signals from any system shall be Hi-Z state or low level when VDD is off



	Power Sequence Timing					
	Value					
Parameter	Min.	Тур.	Max.	Units		
T1	0.5	-	10			
T2	0	-	50			
Т3	200	-	-			
T4	0.5	-	10			
T5	10	-	-			
Т6	10	-	-			
Т7	0	-	-	ms		
Т8	10	-	-			
Т9	0	-	10			
T10	200	-	-			
T11	0.5	-	50			
T12	0	-	10			
T13	400	-	-			

Note:If T3,T5,T6 couldn't match above specifications, must request $\underline{T3+T5+T6} > \underline{200ms}$ at least

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7. Connector Description

Physical interface is described as for the connector on module.

These connectors are capable of accommodating the following signals and will be following components.

7.1 TFT LCD Module

Connector Name / Designation	For Signal Connector				
Manufacturer	IPEX or compatible				
Type / Part Number	IPEX 20347-340E-12 or compatible				
Mating Housing/Part Number	IPEX 20345 series or compatible				

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8. 8. LED Driving Specification

8.1 Connector Description

It is a intergrative interface and comibe into LVDS connector. The type and mating refer to section 7.

8.2 Pin Assignment

Ref. to 6.3

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9. Vibration and Shock Test

9.1 Vibration Test

Test Spec:

Test method: Non-Operation

Acceleration: 1.5 G

Frequency: 10 - 500Hz Random

Sweep: 30 Minutes each Axis (X, Y, Z)

9.2 Shock Test Spec:

Test Spec:

Test method: Non-Operation

Acceleration: 220 G, Half sine wave

Active time: 2 ms

Pulse: X,Y,Z .one time for each side

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Items	Required Condition	Note
Temperature Humidity Bias	Ta= 40℃, 90%RH, 300h	
High Temperature Operation	Ta= 50℃, Dry, 300h	
Low Temperature Operation	Ta= 0℃, 300h	
High Temperature Storage	Ta= 60℃, 300h	
Low Temperature Storage	Ta= -20℃, 300h	
Thermal Shock Test	Ta=-20℃to 60℃, Duration at 30 min, 100 cycles	
ESD	Contact : ±8 KV	Note 1
LSD	Air: ±15 KV	

Note1: According to EN 61000-4-2, ESD class B: Some performance degradation allowed. No data lost

. Self-recoverable. No hardware failures.

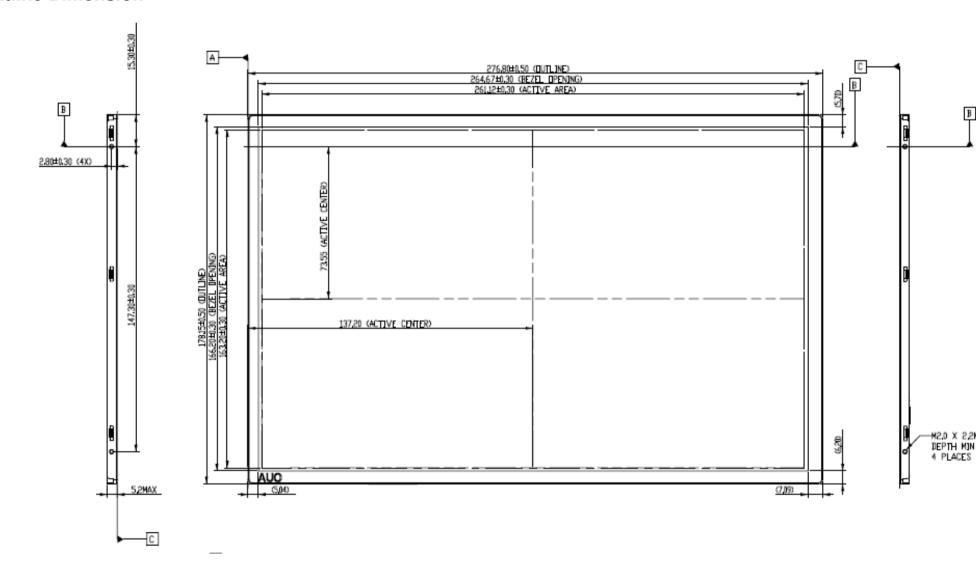
Remark: MTBF (Excluding the LED): 30,000 hours with a confidence level 90%



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11. Mechanical Characteristics

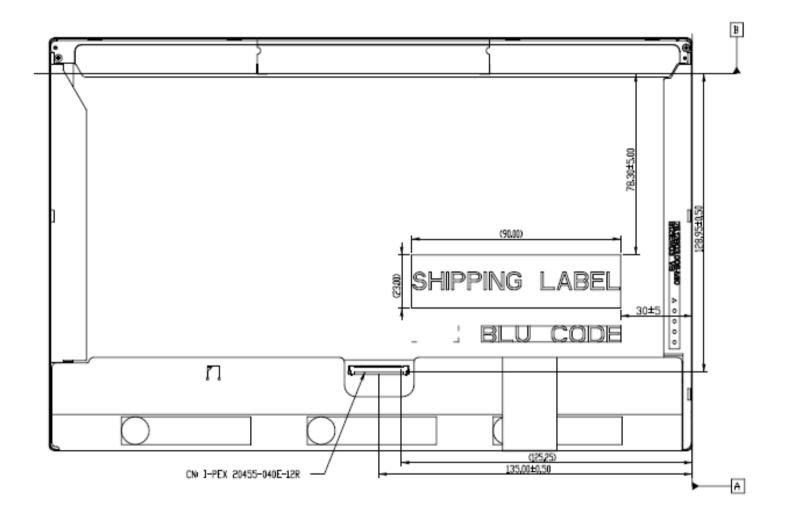
11.1 LCM Outline Dimension



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12. Shipping and Package

12.1 Shipping Label Format



Manufactured 10/52 Model No: **B121EW09 V6**

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MADE IN CHINA (\$1)

H/W: 0A F/W:1

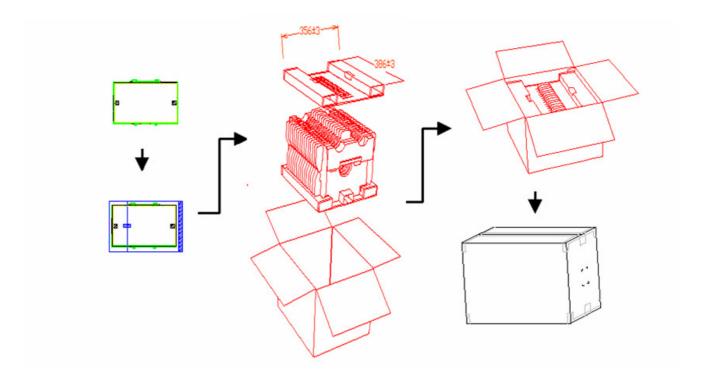




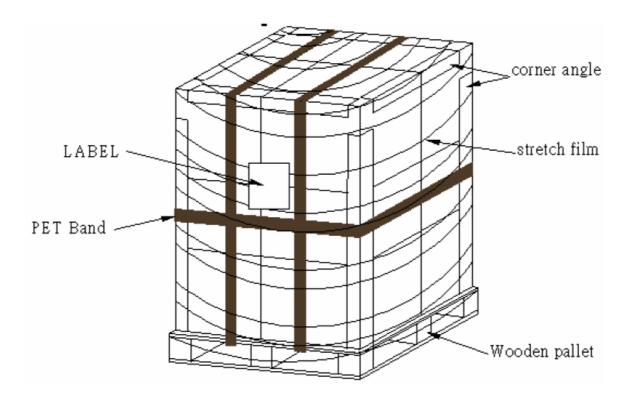
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12.2 Carton package



12.3 Shipping package of palletizing sequence





13. Appendix: EDID description

Address	FUNCTION	Value	Value	Value	Note
HEX		HEX	BIN	DEC	
00	Header	00	00000000	0	
01		FF	11111111	255	
02		FF	11111111	255	
03		FF	11111111	255	
04		FF	11111111	255	
05		FF	11111111	255	
06		FF	11111111	255	
07		00	00000000	0	
08	EISA Manuf. Code LSB	06	00000110	6	
09	Compressed ASCII	AF	10101111	175	
0A	Product Code	1C	00011100	28	
0B	hex, LSB first	96	10010110	150	
0C	32-bit ser #	00	00000000	0	
0D		00	00000000	0	
0E		00	00000000	0	
0F		00	00000000	0	
10	Week of manufacture	01	00000001	1	
11	Year of manufacture	14	00010100	20	
12	EDID Structure Ver.	01	0000001	1	
13	EDID revision #	04	00000100	4	
14	Video input def. (digital I/P, non-TMDS, CRGB)	90	10010000	144	
15	Max H image size (rounded to cm)	1A	00011010	26	
16	Max V image size (rounded to cm)	0E	00001110	14	
17	Display Gamma (=(gamma*100)-100)	78	01111000	120	
18	Feature support (no DPMS, Active OFF, RGB, tmg Blk#1)	02	00000010	2	
19	Red/green low bits (Lower 2:2:2:2 bits)	99	10011001	153	
1A	Blue/white low bits (Lower 2:2:2:2 bits)	85	10000101	133	
1B	Red x (Upper 8 bits)	95	10010101	149	
1C	Red y/ highER 8 bits	55	01010101	85	
1D	Green x	56	01010110	86	
1E	Green y	92	10010010	146	
1F	Blue x	28	00101000	40	
20	Blue y	22	00100010	34	
21	White x	50	01010000	80	
22	White y	54	01010100	84	
23	Established timing 1	00	00000000	0	
24	Established timing 2	00	00000000	0	 _
25	Established timing 3	00	00000000	0	
26	Standard timing #1	01	00000001	1	
27	Ote adead? 1 #2	01	00000001	1	
28	Standard timing #2	01	00000001	1	
29	Oter dead Parker #0	01	00000001	1	1
2A	Standard timing #3	01	00000001	1	
2B	Chandoud the trans #4	01	00000001	1	
2C	Standard timing #4	01	00000001	1	
2D	Chandoud the transfer HF	01	00000001	1	
2E 2F	Standard timing #5	01	00000001	1	
	Chandaud timina #0	01	00000001	1	
30	Standard timing #6	01	00000001	1	
31		01	00000001	1	



	0: 1 1: 1: 17	1 04	0000001	د ا	ſ
32 33	Standard timing #7	01	00000001 00000001	1	
33	Oten dead their a #0	-			
35	Standard timing #8	01	00000001	1	
36	Pixel Clock/10000 LSB	01	00000001	1	-
36		26 1B	00100110	38 27	-
38	Pixel Clock/10000 USB	1B	00011011		
38	Horz active Lower 8bits	00	00000000	0	
	Horz blanking Lower 8bits	64	01100100	100	
3A 3B	HorzAct:HorzBlnk Upper 4:4 bits Vertical Active Lower 8bits	50	01010000 00100000	80 32	-
3B 3C	Vertical Blanking Lower 8bits	20			-
3D	<u> </u>	26	00100110	38	
	• • • • • • • • • • • • • • • • • • • •	30	00110000	48	
3E	HorzSync. Offset	18	00011000	24	
3F	HorzSync.Width	E	00001110	14	
40	VertSync.Offset : VertSync.Width	24	00100100	36	
41	Horz‖ Sync Offset/Width Upper 2bits	00	00000000	0	
42	Horizontal Image Size Lower 8bits	00	00000000	0	
43	Vertical Image Size Lower 8bits	90	10010000	144	
44	Horizontal & Vertical Image Size (upper 4:4 bits)	10	00010000	16	-
45	Horizontal Border (zero for internal LCD)	00	00000000	0	
46	Vertical Border (zero for internal LCD)	00	00000000	0	<u> </u>
47	Signal (non-intr, norm, no stero, sep sync, neg pol)	18	00011000	24	
48	Detailed timing/monitor	00	0000000	0	
49	descriptor #2	00	0000000	0	
4A		00	00000000	0	
4B		0F	00001111	15	
4C		00	00000000	0	
4D		00	00000000	0	
4E		00	00000000	0	
4F		00	00000000	0	
50		00	00000000	0	
51		00	00000000	0	
52		00	00000000	0	
53		00	00000000	0	
54		00	00000000	0	
55		00	00000000	0	
56		00	00000000	0	
57		00	00000000	0	
58		00	00000000	0	
59		20	00100000	32	
5A	Detailed timing/monitor	00	00000000	0	
5B	descriptor #3	00	00000000	0	
5C		00	00000000	0	
5D		FE	11111110	254	
5E		00	00000000	0	
5F	Manufacture	41	01000001	65	Α
60	Manufacture	55	01010101	85	U
61	Manufacture	4F	01001111	79	0
62		0A	00001010	10	
63		20	00100000	32	
64		20	00100000	32	
65		20	00100000	32	
66		20	00100000	32	
67		20	00100000	32	
68		20	00100000	32	



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69		20	00100000	32	
6A		20	00100000	32	
6B		20	00100000	32	
6C	Detailed timing/monitor	00	00000000	0	
6D	descriptor #4	00	00000000	0	
6E		00	00000000	0	
6F		FE	11111110	254	
70		00	00000000	0	
71	Manufacture P/N	42	01000010	66	В
72	Manufacture P/N	31	00110001	49	1
73	Manufacture P/N	32	00110010	50	2
74	Manufacture P/N	31	00110001	49	1
75	Manufacture P/N	45	01000101	69	Е
76	Manufacture P/N	57	01010111	87	W
77	Manufacture P/N	30	00110000	48	0
78	Manufacture P/N	39	00111001	57	9
79	Manufacture P/N	20	00100000	32	
7 A	Manufacture P/N	56	01010110	86	V
7B	Manufacture P/N	36	00110110	54	6
7C		20	00100000	32	
7D		0A	00001010	10	
7E	Extension Flag	00	00000000	0	
7F	Checksum	0D	00001101	13	